FORM PTO-1595

REC

06-06-2001

101741664

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

ET

2. Name and address of receiving party(ies)

Street Address: Postfach 22 16 34

Internal Address; ZT GG VM

Name: Siemens Aktiengesellschaft

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

1. Name of conveying party(ies):

Dominique Savignac

(Rev. 6-93) 6 01.01

OMB No. 0651-0011 (exp. 4/94)

Tab settings ⇒⇒⇒

Helmut Schneider

(Additional name(s) of conveying party(ies) attached) Y es ⊠No

- 3. Nature of conveyance:
- □ Merger
- □ Security Agreement

□ Other

Execution Date: August 3, 1999

□ Change of Name

Additional name(s) & address(es) attached □Yes ☑No

City: München State: Germany ZIP: 80506

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

B. Patent No.(s)

09/363,263

Additional numbers attached ☐ Yes ⊠No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Lerner and Greenberg

Internal Address: ____

Street Address: P.O. Box 2480

City: Hollywood

ZIP: 33022

6. Total number of applications and patents involved:

7. Total fee (37 CFR 3.41)\$ 40.00

□ Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page by deposit account)

DO NOT USE THIS SPACE

Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

RALPH E. LOCHER REG. NO. 41.947

Name of Person Signing

May 29, 2001

Date

Total number of pages including cover sheet, attachments, and document:

PATENT

REEL: 011853 FRAME: 0803

Docket No.: GR 98 P 2185

ASSIGNMENT

WHEREAS WE, DOMINIQUE SAVIGNAC and HELMUT SCHNEIDER, residing respectively at ISMANING and MÜNCHEN, Germany, have invented certain new and useful improvements in an

INTEGRATED SEMICONDUCTOR CHIP WITH MODULAR DUMMY STRUCTURES

for which an application for Letters Patent of the United States of America was executed on the date of execution of this assignment;

WHEREAS, SIEMENS AKTIENGESELLSCHAFT, a German corporation doing business at München, Germany, is desirous of acquiring the entire interest in said invention, and in any and all Letters Patent of the United States that may be obtained therefor;

NOW, THEREFORE, be it known that for and in consideration of our employment by the said corporation and other valuable consideration, the receipt and sufficiency whereof are hereby acknowledged, we have sold, assigned and transferred, and by these presents do sell, assign and transfer unto the said corporation, its legal representatives, successors and assigns, the full and exclusive right to the said invention as fully set forth and described in the above-mentioned application, and to said application and any and all divisions and continuations thereof, and any and all Letters Patent of the United States which may be granted therefor, and any and all reissues of said Letters Patent, the same to be held and enjoyed by the said corporation, its legal representatives, successors and assigns, to the full end of the term for which said Letters Patent may be granted or may be reissued or extended, as fully and entirely as the same would have been held by us had this assignment and sale not been made.

AND WE hereby authorize the Commissioner of Patents to Issue any and all Letters Patent of the United States on said Invention or resulting from said Application and from any and all divisions and continuations thereof to the said corporation as the assignee of the entire right, title and interest in and to the same.

IN TESTIMONY WHEREOF, we have hereunto set our hands and seals.

In the presence of:

DOMINIQUE SAVIGNAC

UTLANT COUNTRIDED

HELMUT SCHNEIDER

Date: 03 Aug. 99

Date: 03 44099

RECORDED: 06/01/2001

PATENT REEL: 011853 FRAME: 0804